

General Description

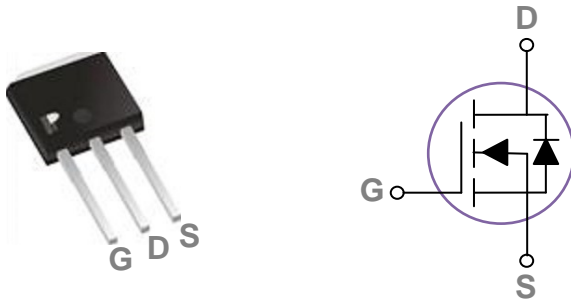
These N-Channel enhancement mode power field effect transistors are planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply

| | | |
|-------|-------|----|
| BVDSS | RDSON | ID |
| 500V | 3.2Ω | 4A |

Features

- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

TO251 Pin Configuration



Applications

- High efficient switched mode power supplies
- TV Power
- Adapter/charger
- Server Power
- PV Inverter / UPS

Absolute Maximum Ratings $T_c=25^{\circ}\text{C}$ unless otherwise noted

| Symbol | Parameter | Rating | Units |
|-----------|--|------------|-----------------------|
| V_{DS} | Drain-Source Voltage | 500 | V |
| V_{GS} | Gate-Source Voltage | ± 30 | V |
| I_D | Drain Current – Continuous ($T_c=25^{\circ}\text{C}$) | 4 | A |
| | Drain Current – Continuous ($T_c=100^{\circ}\text{C}$) | 2.5 | A |
| I_{DM} | Drain Current – Pulsed ¹ | 16 | A |
| EAS | Single Pulse Avalanche Energy ² | 20 | mJ |
| IAS | Single Pulse Avalanche Current ² | 6.4 | A |
| P_D | Power Dissipation ($T_c=25^{\circ}\text{C}$) | 42 | W |
| | Power Dissipation – Derate above 25°C | 0.34 | W/ $^{\circ}\text{C}$ |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^{\circ}\text{C}$ |
| T_J | Operating Junction Temperature Range | -55 to 150 | $^{\circ}\text{C}$ |

Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|--|------|------|-----------------------------|
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | --- | 62 | $^{\circ}\text{C}/\text{W}$ |
| $R_{\theta JC}$ | Thermal Resistance Junction to Case | --- | 3 | $^{\circ}\text{C}/\text{W}$ |

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)
Off Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|------------------------------|------------------------------------|--|------|------|-----------|--------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_D=250\mu A$ | 500 | --- | --- | V |
| $\Delta BV_{DSS}/\Delta T_J$ | BV_{DSS} Temperature Coefficient | Reference to 25°C , $I_D=1\text{mA}$ | --- | 0.6 | --- | $V/^\circ\text{C}$ |
| I_{DSS} | Drain-Source Leakage Current | $V_{DS}=500V, V_{GS}=0V, T_J=25^\circ\text{C}$ | --- | --- | 1 | μA |
| | | $V_{DS}=400V, V_{GS}=0V, T_J=125^\circ\text{C}$ | --- | --- | 10 | μA |
| I_{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 30V, V_{DS}=0V$ | --- | --- | ± 100 | nA |

On Characteristics

| | | | | | | |
|---------------------|--------------------------------------|-------------------------------|-----|-----|-----|----------------------------|
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance | $V_{GS}=10V, I_D=1A$ | --- | 2.6 | 3.2 | Ω |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}=V_{DS}, I_D=250\mu A$ | 3 | 4 | 5 | V |
| $\Delta V_{GS(th)}$ | $V_{GS(th)}$ Temperature Coefficient | | --- | -8 | --- | $\text{mV}/^\circ\text{C}$ |
| g_{fs} | Forward Transconductance | $V_{DS}=10V, I_D=1A$ | --- | 2.7 | --- | S |

Dynamic and switching Characteristics

| | | | | | | |
|--------------|------------------------------------|---|-----|-----|-----|----------|
| Q_g | Total Gate Charge ^{3,4} | $V_{DS}=400V, V_{GS}=10V, I_D=1A$ | --- | 10 | --- | nC |
| Q_{gs} | Gate-Source Charge ^{3,4} | | --- | 2.6 | --- | |
| Q_{gd} | Gate-Drain Charge ^{3,4} | | --- | 3.2 | --- | |
| $T_{d(on)}$ | Turn-On Delay Time ^{3,4} | $V_{DD}=300V, V_{GS}=10V, R_G=25\Omega$ $I_D=1A$ | --- | 18 | --- | ns |
| T_r | Rise Time ^{3,4} | | --- | 10 | --- | |
| $T_{d(off)}$ | Turn-Off Delay Time ^{3,4} | | --- | 26 | --- | |
| T_f | Fall Time ^{3,4} | | --- | 22 | --- | |
| C_{iss} | Input Capacitance | $V_{DS}=25V, V_{GS}=0V, F=1\text{MHz}$ | --- | 435 | --- | pF |
| C_{oss} | Output Capacitance | | --- | 34 | --- | |
| C_{riss} | Reverse Transfer Capacitance | | --- | 4 | --- | |
| R_g | Gate resistance | $V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$ | --- | 1.9 | --- | Ω |

Drain-Source Diode Characteristics and Maximum Ratings

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------|--------------------------------------|---|------|------|------|---------|
| I_S | Continuous Source Current | $V_G=V_D=0V$, Force Current | --- | --- | 4 | A |
| I_{SM} | Pulsed Source Current | | --- | --- | 16 | A |
| V_{SD} | Diode Forward Voltage | $V_{GS}=0V, I_S=1A, T_J=25^\circ\text{C}$ | --- | --- | 1 | V |
| t_{rr} | Reverse Recovery Time ³ | $V_{GS}=0V, I_S=1A, dI/dt=100A/\mu s$ | --- | --- | --- | nS |
| Q_{rr} | Reverse Recovery Charge ³ | $T_J=25^\circ\text{C}$ | --- | --- | --- | μC |

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{DD}=50V, V_{GS}=10V, L=1\text{mH}, I_{AS}=7A, R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$.
3. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.

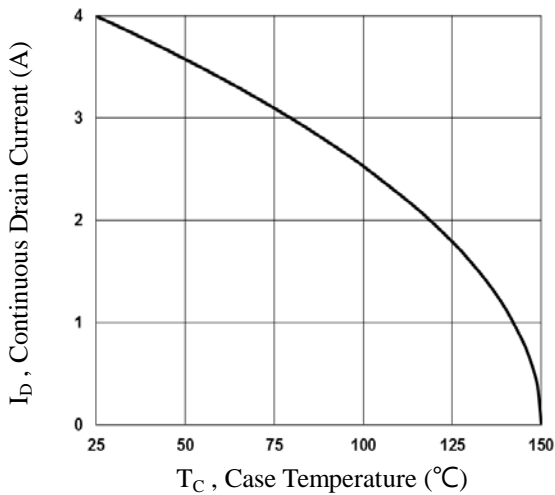


Fig.1 Continuous Drain Current vs. T_C

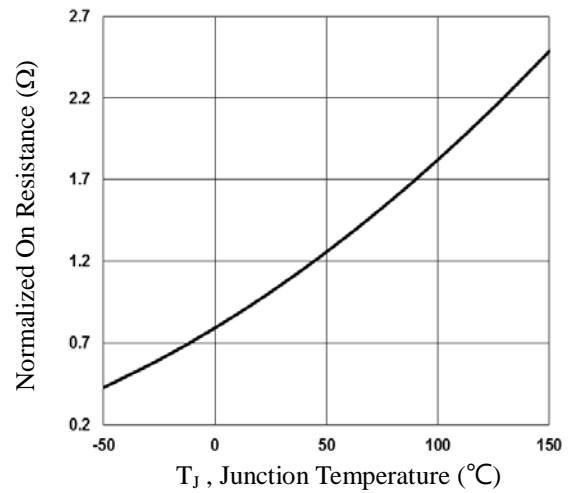


Fig.2 Normalized $R_{DS(on)}$ vs. T_J

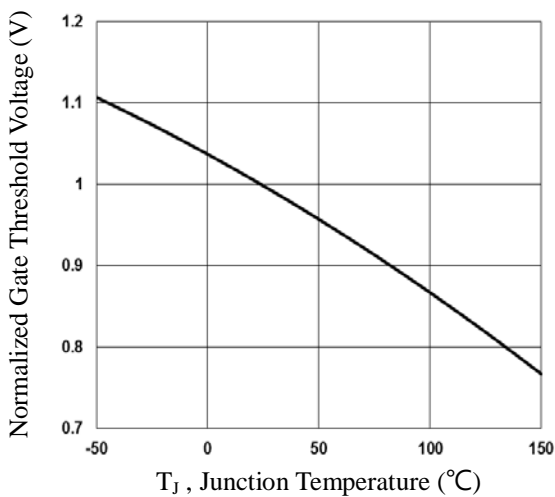


Fig.3 Normalized V_{th} vs. T_J

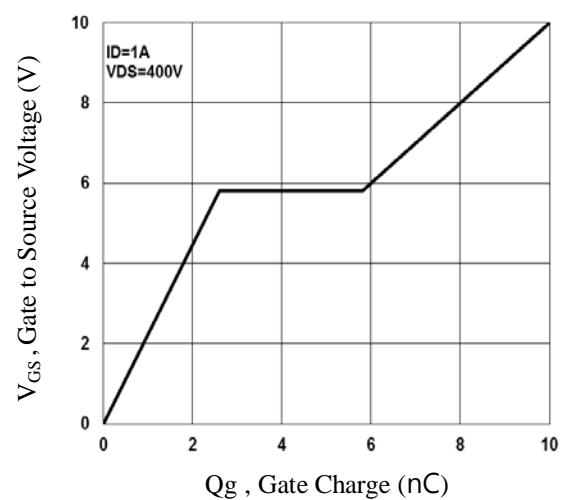


Fig.4 Gate Charge Waveform

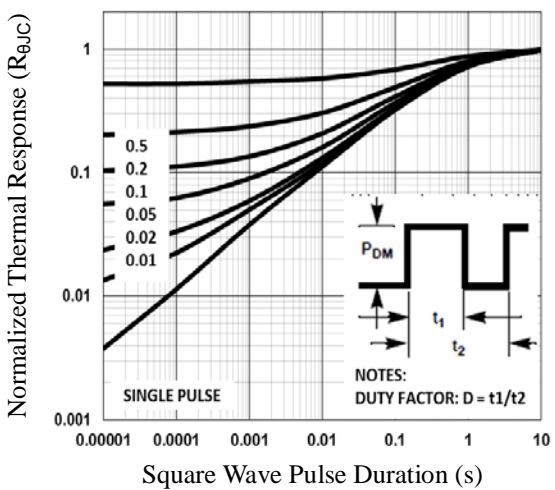


Fig.5 Normalized Transient Impedance

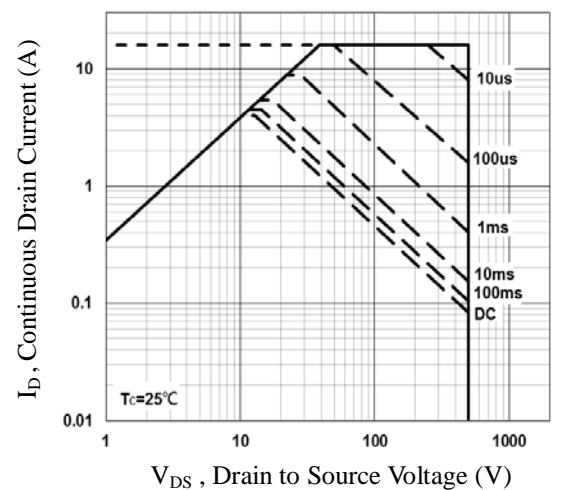


Fig.6 Maximum Safe Operation Area

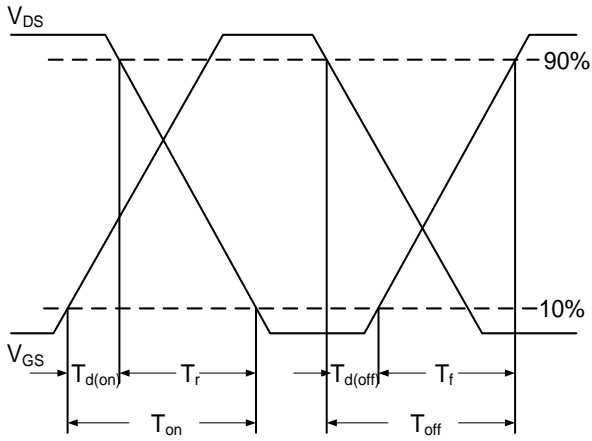


Fig.7 Switching Time Waveform

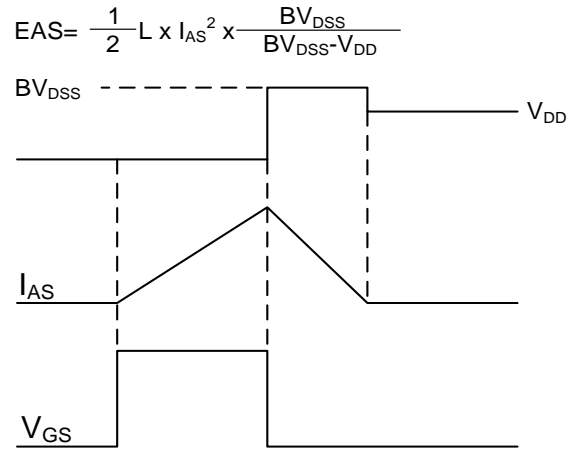
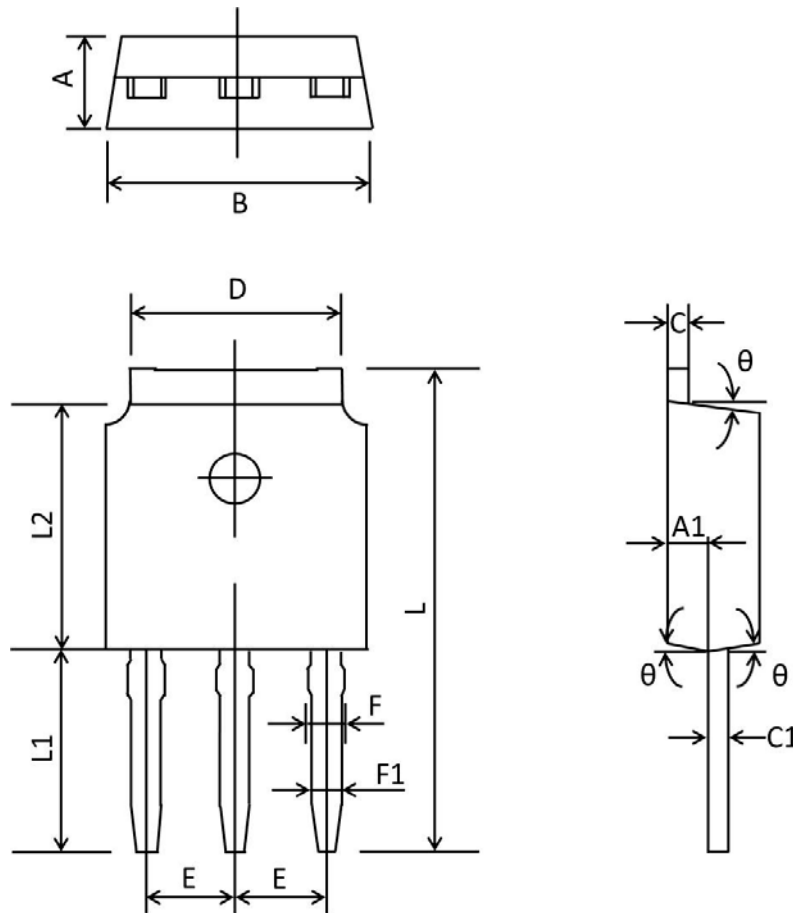


Fig.8 EAS Waveform

TO251 PACKAGE INFORMATION



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|----------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 2.20 | 2.40 | 0.087 | 0.094 |
| A1 | 0.91 | 1.11 | 0.036 | 0.044 |
| B | 6.50 | 6.70 | 0.256 | 0.264 |
| C | 0.46 | 0.580 | 0.018 | 0.230 |
| C1 | 0.46 | 0.580 | 0.018 | 0.030 |
| D | 5.10 | 5.46 | 0.201 | 0.215 |
| E | 2.186 | 2.386 | 0.086 | 0.094 |
| F | 0.74 | 0.94 | 0.029 | 0.037 |
| F1 | 0.660 | 0.860 | 0.026 | 0.034 |
| L | 11.70 | 12.30 | 0.461 | 0.484 |
| L1 | 4.8 | 5.2 | 0.189 | 0.205 |
| L2 | 6.00 | 6.20 | 0.236 | 0.244 |
| θ | 3° | 9° | 3° | 9° |